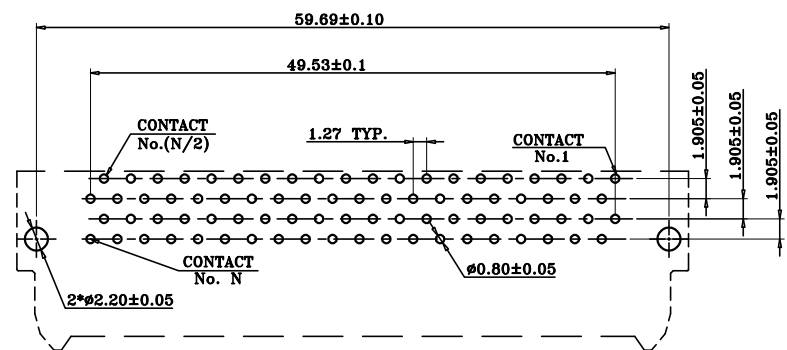
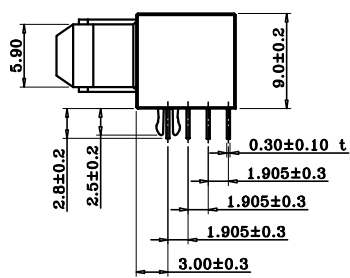
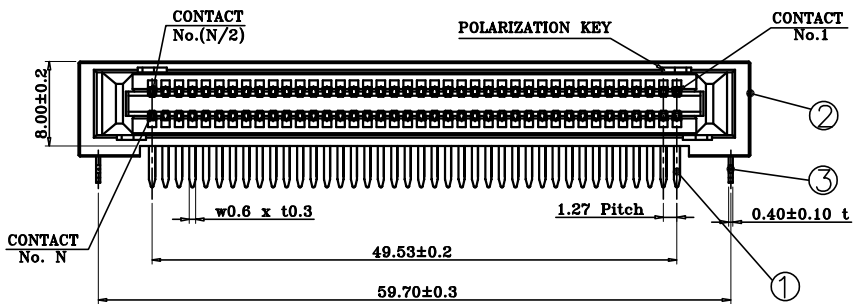
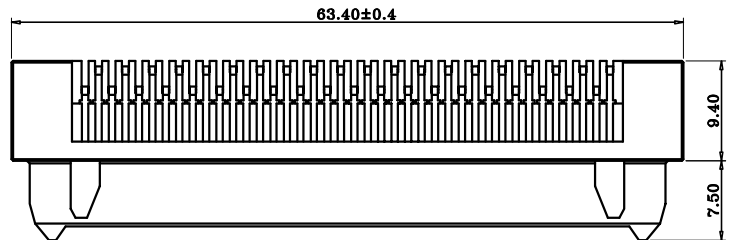


1	2	3	4	5	6	7	8	
				REV	LTR	DESCRIPTION	DATE	DWN



APPLICABLE P.C.B DIMENSION(REF.)
(40,60,80,100,POSITIONS)

- NOTES:
- MATERIALS:
 - HOUSING: PBT+30%GF,UL-HB,COLOR:BLACK
 - TERMINALS: Copper Alloy T=0.30mm
 - HOOK PIN: Copper Alloy T=0.40mm
 - PLATING
 - TERMINALS:
 - NICKEL 30 μ" MIN UNDERPLATED, TIN 80 μ" MIN ON SOLDER TAIL AREA, Au ON CONTACT ARER -SEE TABLE;
 - HOOK PIN:
 - NICKEL 30 μ" MIN UNDERPLATED, TIN 80 μ" MIN OVER ALL.
 - IR SOLDER CAPABLE TO 245±5°C FOR 3±0.5S.
 - ROHS COMPLIANT.
 - ELECTRICAL PERFORMANCE:
 - INSULATION RESISTANCE: DC 100V/50MΩ MIN. ;
 - DIELECTRIC WITHSTANDING VOLTAGE: 100VAC r.m.s.(for one minute),
 - CONTACT RESISTANCE: 50mQMAX.(INITIAL); 100mQMAX.(AFTER LIFE TEST)
 - ENVIRONMENTAL CHARACTERISTICS:
 - STORAGE TEMPERATURE RANGE:-25°C~+85°C
 - OPERATION TEMPERATURE RANGE:-25°C~+85°C

ORDER INFORMATION
EAST-080 01 X 02 XX X X

No. of Pins: _____
Plating: _____
Environment Protection: _____
Packing: _____
HSG Color: _____
K1:Black, L1:White

A-Flash,Gold in contact area/
80u" Min Tin in solder area.
B-3u" Min.Gold in contact area/
80u" Min Tin in solder area.
C-5u" Min.Gold in contact area/
80u" Min Tin in solder area.
D-10u" Min.Gold in contact area/
80u" Min Tin in solder area.
E-15u" Min.Gold in contact area/
80u" Min Tin in solder area.
G-30u" Min.Gold in contact area/
80u" Min Tin in solder area.

3	HOOK PIN	2	COPPER ALLOY	(LEAD FREE)TIN/TIN ALLOY	
2	INSULATOR	1	GLASS FILLED PBT		UL-HB/BLACK
1	CONTACT	N	COPPER ALLOY	SEE TABLE2	
符号 NO.	名称 DESCRIPTION	个数 QTY.	材料 MATERIAL	电镀 FINISH	备注 REMARKS
TOLERANCE			深圳市东方御业科技有限公司 Tel:0755-27155560 WWW.DFYCONN.COM		TITLE: TX24 Connector 80Pin
LINEAR	ANGLES				PART NO.: SEE TABLE
X.±0.80	X'.±2.0'				DWG NO.: EAST-08001A02K1ER
.X±0.40	.X'±1.0'				UNITS SCALE SHEET REV
.XX±0.25	.XX'±	APPD:	DRWN: Rocky	MM 1:1	1 OF 1 A/0
.XXX±0.15	.XXX'±	CHKD:	DATE: 2016-5-22		